

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re the Application of
Lee D. Whetsel

TI-32417

Serial No.: TBD

Art Unit: TBD

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Examiner: TBD

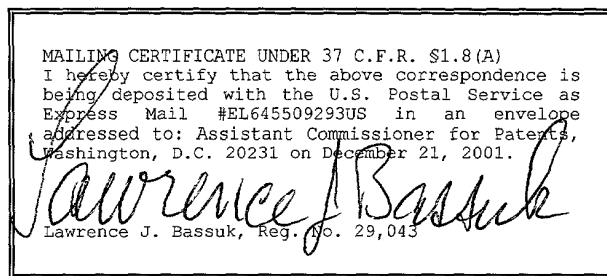
Title: Interconnections for Plural and Hierarchical P1500 Test Wrappers

LETTER TO THE OFFICIAL DRAFTSPERSON

December 21, 2001


Assistant Commissioner for
Patents
Washington, D. C. 20231

Dear Sir:



Applicant submits 16 sheets (24 Figs.) of formal drawings for the above-identified patent application.

Respectfully submitted,

Respectfully submitted,

 Lawrence J. Bassuk
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